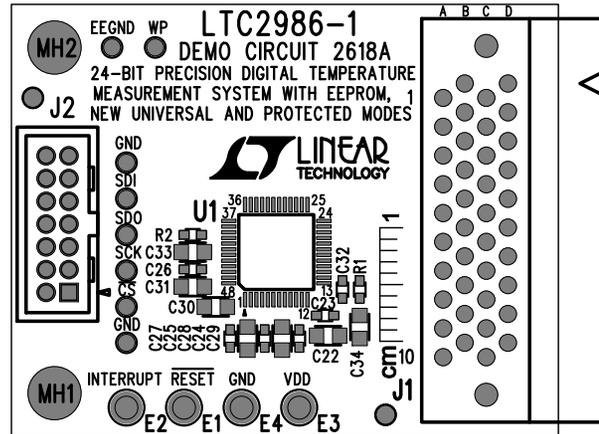


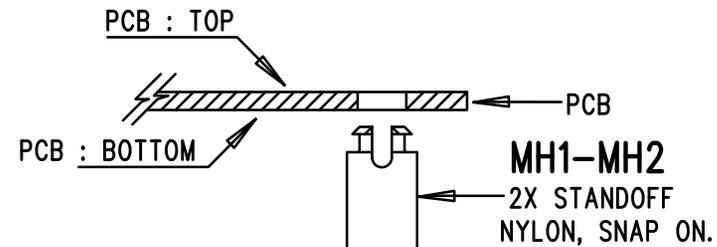
REVISION HISTORY

ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	1	PRODUCTION	LOGAN C.	10-10-16



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. NO SHUNT.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL 2 STANDOFFS AS SHOWN BELOW:



APPROVALS		 1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY			
PCB DES.	KIM T.			TITLE: TOP ASSEMBLY DRAWING 24-BIT PRECISION DIGITAL TEMPERATURE MEASUREMENT SYSTEM WITH EEPROM, NEW UNIVERSAL AND PROTECTED MODES	
APP ENG.	LOGAN C.				
SIZE	IC NO.	LTC2986CLX-1	REV.		
N/A		DEMO CIRCUIT 2618A	1		
SCALE = NONE		FILENAME:	DC2618A-1.PCB	SHT 1 OF 2	